



General Description

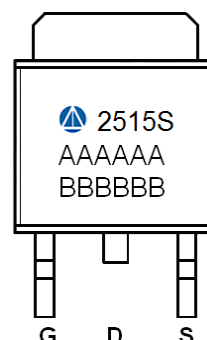
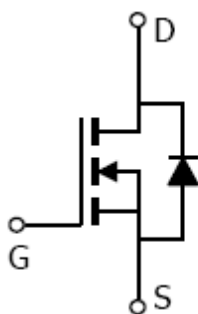
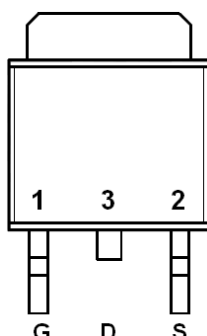
AFN2515S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- 150V/15A, $R_{DS(ON)} = 64m\Omega @ V_{GS}=10V$
- 150V/10A, $R_{DS(ON)} = 70m\Omega @ V_{GS}=6V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- TO-252-2L package design

Pin Description (TO-252-2L)



Application

- High Frequency Boost Converter
- LED Backlight for LCD TV

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN2515ST252RG	2515S	TO-252-2L	Tape & Reel	2500 EA

※ A Lot code

※ B Date code

※ AFN2515ST252RG : 13" Tape & Reel ; Pb- Free ; Halogen- Free



Absolute Maximum Ratings

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	150	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	25	A
		15	
Pulsed Drain Current	I _{DM}	50	
Continuous Source Current(Diode Conduction)	I _S	25	
Single Pulse Avalanche Current	I _{AS}	25	
Power Dissipation	P _D	40	W
		15	
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	62.5	°C/W

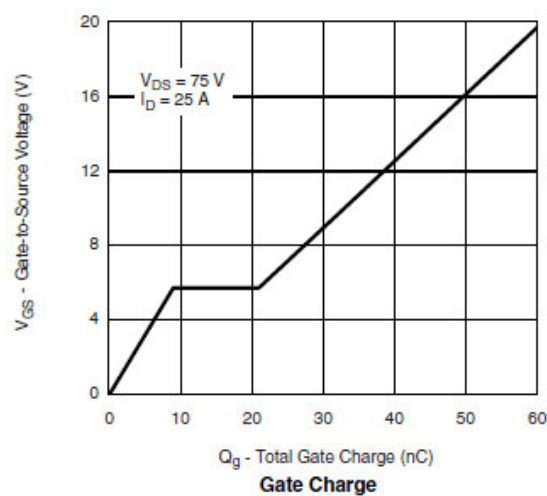
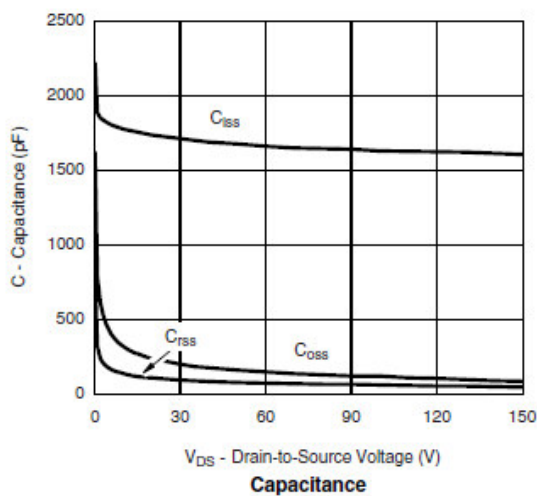
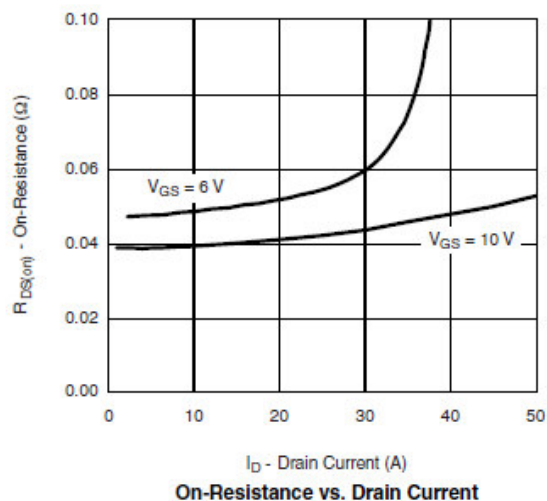
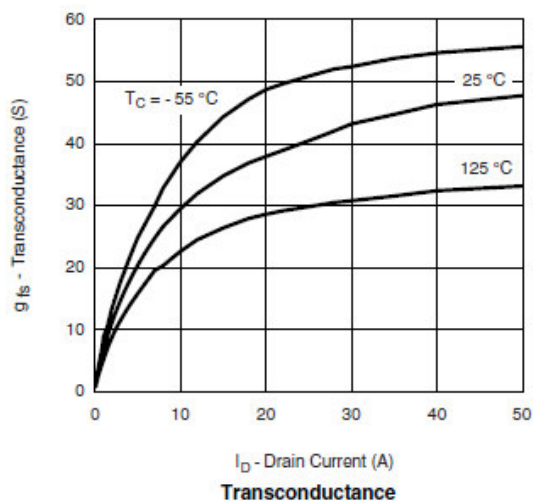
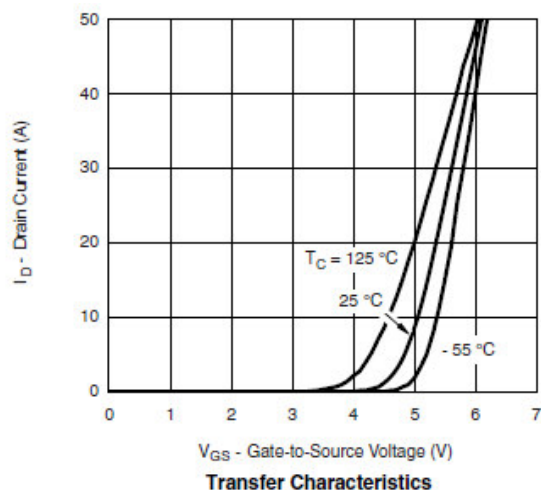
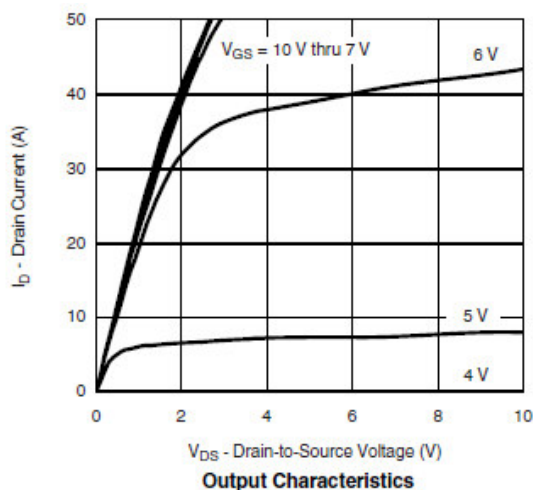
Electrical Characteristics

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	150			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2	3	4	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =120V, V _{GS} =0V			1	uA
		V _{DS} =120V, V _{GS} =0V T _J =85°C			5	
On-State Drain Current	I _{D(on)}	V _{DS} ≥ 5V, V _{GS} =10V	25			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A		54	64	mΩ
		V _{GS} =6V, I _D =6A		58	70	
Forward Transconductance	g _{FS}	V _{DS} =15V, I _D =25A		40		S
Diode Forward Voltage	V _{SD}	I _S =2.5A, V _{GS} =0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =75V, V _{GS} =10V I _D ≡25A		30	50	nC
Gate-Source Charge	Q _{gs}			10		
Gate-Drain Charge	Q _{gd}			12		
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V f=1MHz		1685		pF
Output Capacitance	C _{oss}			215		
Reverse Transfer Capacitance	C _{rss}			100		
Turn-On Time	t _{d(on)}	V _{DD} =50V, R _L =3Ω I _D ≡25A, V _{GEN} =10V R _G =2.5Ω		15	30	ns
	t _r			70	135	
Turn-Off Time	t _{d(off)}			25	50	
	t _f			60	100	

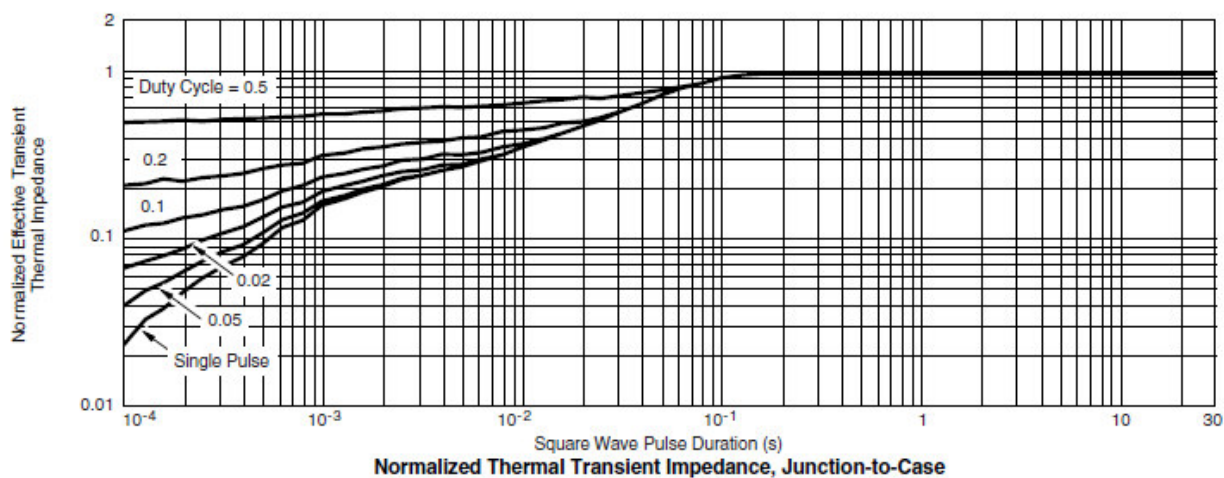
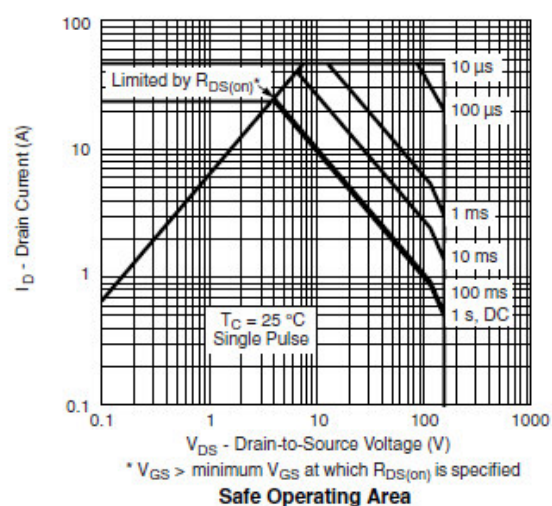
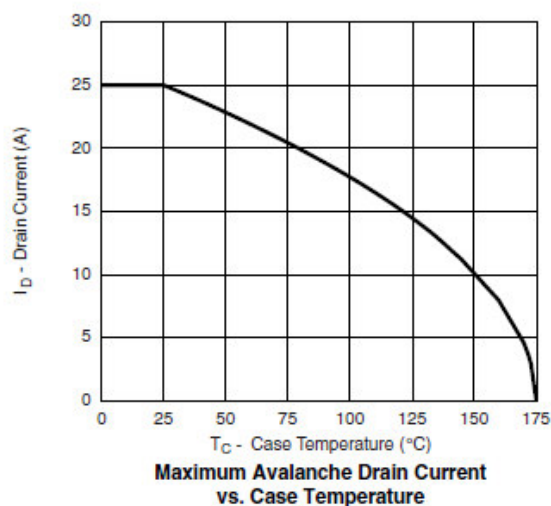
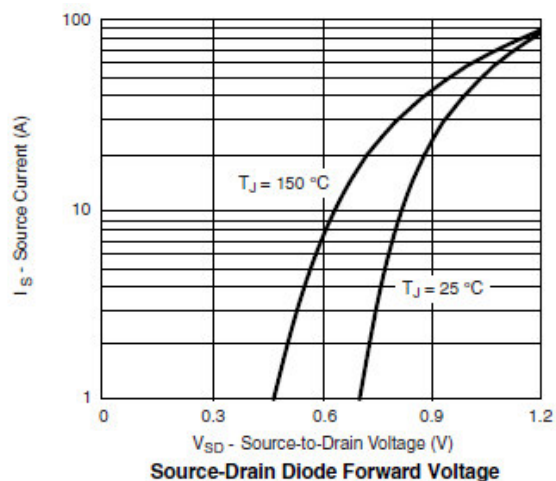
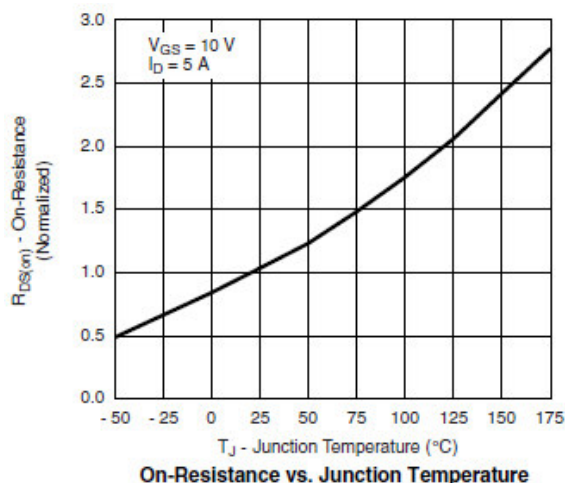


Typical Characteristics





Typical Characteristics





Typical Characteristics

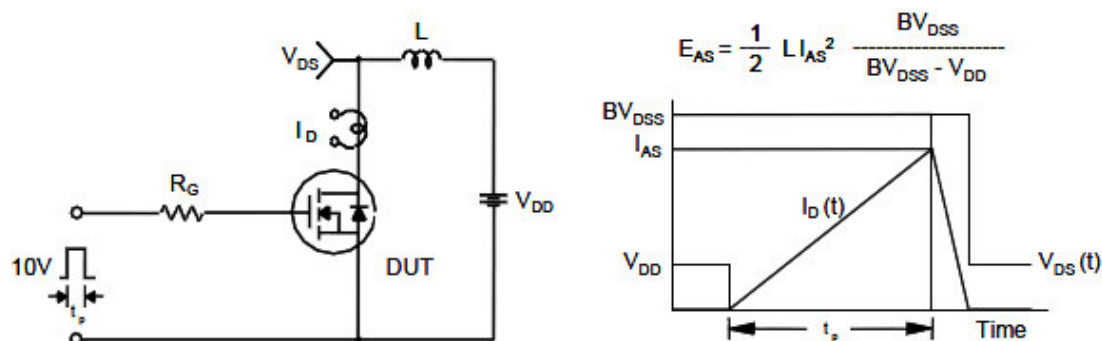
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

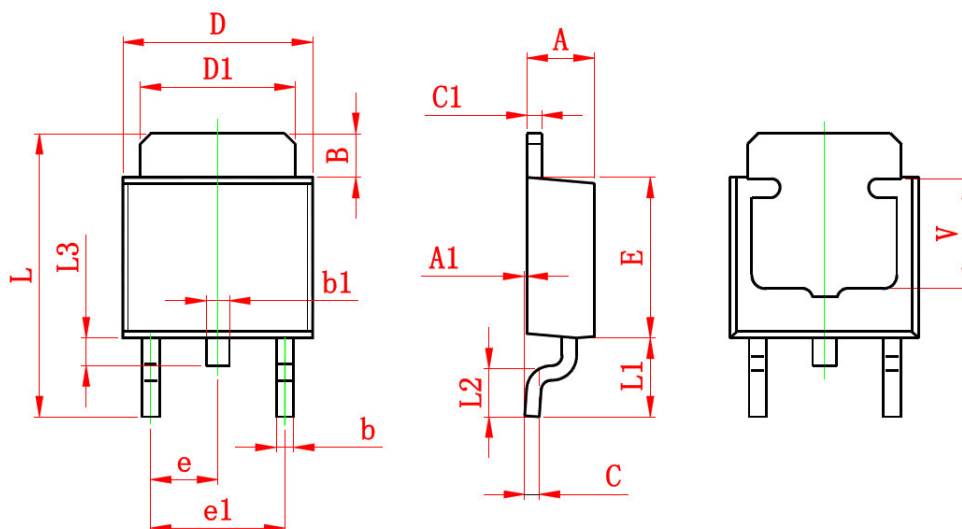


Unclamped Inductive Switching Test Circuit & Waveforms





Package Information (TO-252-2L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

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